

## Riedel SmartPanel RSP-1216HL

Building upon the technology that powers Riedel's SmartPanel app-driven user interfaces, the new 1200 Series RSP-1216HL multifunctional user interface features multiple full-color multi-touchscreen displays, 16 innovative hybrid lever keys, the ability to leverage apps for multifunctionality, and the ability to easily adapt to the various workflows in use today. This new panel is poised to allow you to work the way you always have while opening up entirely new workflow possibilities.

In addition to full-color touchscreens and support for multiple workflows, each of the 16 hybrid lever keys features an innovative integrated rotary encoder that provides control over variable parameters in the same location as the key itself. Each key also has an LED ring which allows for easy grouping of keys based on colors. Key Banks, a new take on shift pages, are user-definable layers of keys that are accessed by the simple press of a button on the screen.

Completely new from the ground up, the 1200 Series SmartPanels are Riedel's smartest panels yet! The SmartPanel concept decouples the panel's capabilities from its hardware and turns it into a generic device on which customers can install different apps to enable different capabilities. With a Riedel SmartPanel, you not only get what the panel is capable of today – but also what it will be capable of in the future.



Rear View



## Legend

- 1) Microphone Connector
- 2) Microphone Status LED
- 3) 2× Multi-touch Color Key Displays
- 4) NFC / Bluetooth Connection (future use)
- 5) Multi-touch Color Info Display
- 6) DSP-controlled Speaker
- 7) Exchangeable Headset Connector
- 8) 16× Hybrid Lever Keys with Rotary Encoder & LED Key rings
- Light sensor / Panel Microphone (future use)
- )) Grey Rotary Encoder (Sidetone Control & Menu Navigation)
- 11) Front USB Connector
- 12) Red Rotary Encoder (Volume Control)
- 13) Mains Power Connector
- 14) 2× SFP Slots (AES67/Ethernet)
- 15) Rear USB Connector

- 16) MicroSD-Card Slot
- 17) Fan (temperature controlled)
- 18) 2× Ethernet Connectors (AES67/Ethernet)
- 19) Expansion / Management Port (future use)
- 20) 2× Artist Matrix Connectors (AES3)21) DisplayPort (future use)
- 22) GPI Input/Output Connectors
- 23) 2× Analog 4-Wire Input/Output Connectors
- 24) 2× Headset Connectors



## Riedel SmartPanel RSP-1216HL

Hardware Front Elements				
Keys & Rotaries	16x software assignable lever le	ous with rotany ancoder and push button		
Keys & Rotaries	16× software-assignable lever keys with rotary encoder and push button			
S:I	2× rotary encoders  3× high-resolution, bright color, sunlight readable TFT displays with multi-touch control (capacitive)			
Displays			oi (capacitive)	
Mic	1× threaded 6.3 mm jack for microphone			
	1× internal panel microphone (future use)			
Headset	User-exchangeable headset connector with preinstalled 4-pin male XLR connector			
Speaker	1× full-range, DSP-controlled			
JSB	1× USB 2.0 (standard Type-A, max. 500 mA)			
NFC	Technology RFID, Frequency 13.56 MHz (future use)			
Bluetooth	Frequency DTS Band 2400 2483.5 MHz (future use)			
ightsensor	Adaptation of the display bright	ness to the environment (future use)		
Rear Elements				
EC	Power Input			
SFP	2× Ethernet ETH 3 / ETH 4 (1000BASE-X, Ethernet, AES67)			
JSB	1× USB 2.0 (standard Type-C, max. 500 mA)			
MicroSD-card	1× MicroSD / MicroSDHC card up to 32 GB (for service purpose only)			
RJ45	2× Ethernet ETH 1 / ETH 2 (1000BASE-T Ethernet, AES67)			
	1× Expansion port for expansion panels			
	1× Management port for panel configuration (future use)			
	1× Artist Matrix connector (AES3)			
	2× Analog audio 4-wire inputs and outputs			
	2× Headset ("Headset A" is identical to front)			
BNC	1× Artist Matrix connector (AES3)			
DisplayPort	1× DisplayPort connector (future use)			
Sub-D9 (male)	3× GPI output, U <sub>MAX</sub> 48 V / 300 mA, protected by self-healing fuse			
Sub-D9 (female)	3× GPI input, U <sub>IN</sub> = +5 V +48 V			
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Vidia Cuasa				
Audio Specs  Maximum Level		124 dD.:	0.0 dpss 21-01d	
	Audio A/B Output	+24 dBu	@ 0 dBFS, 2 kΩ load	
	· ·	+23 dBu	@ 0 dBFS, 600 Ω load	
	Audio A/B Input	+24 dBu	≙ 0 dBFS	
	Headset Phones	+20.5 dBu	@ 0 dBFS, 150 Ω load	
	Headset Microphone	+6 dBu	≙ -6 dBFS	
	Internal Speaker	max. 101 dB SPL	@ 1 m	
Frequency Response	Panel/Internal Mic (electret)	70 Hz 20 kHz, -3 dB (70 Hz high-pass filter)	@ 25 μA (≙ 110 dB SPL)	
	Headset Mic A/B	20 Hz 20 kHz, -0.1 dB	@ -20 dBFS (-20 dBu), -12 dB internal gain	
	Headset Phones	20 Hz 20 kHz, -0.4 dB	@ -20 dBFS, 150 Ω load	
	Audio A/B Input	20 Hz 20 kHz, -0.4 dB	@ -20 dBFS (+4 dBu), 150 Ω source	
	Audio A/B Output	20 Hz 20 kHz, -0.3 dB	@ -20 dBFS, 600 Ω load	
	Internal Speaker	140 Hz 16.6 kHz, -10 dB	C	
	Panel Mic	<0.03 %, 70 Hz 20 kHz	@ 25 µA (≙ 110dB SPL)	
	Headset Mic A/B	<0.004 %, 20 Hz 20 kHz	@ -1 dBFS (-1 dBu), -12 dB internal gain	
Distortion THD+N	i reduser with AVD	<0.10 %, 20 Hz 20 KHZ	e - 1 ddr3 (-1 ddd), -12 dd lliteiridi galli	
			@ -1 dBFS, 150 Ω load	
	Headset Phones	<0.004 %, 200 Hz 20 kHz		
		<0.03 %, 20 Hz 200 Hz	@ -20 dBFS, 150 Ω load	
		<0.004 %, 200 Hz 20 kHz		
	Audio A/B Input	<0.010 %, 20 Hz 20 kHz	@ -1 dBFS (+23 dBu), 150 Ω source	
	·	<0.004 %, 20 Hz 20 kHz	@ -20 dBFS (+4 dBu), 150 Ω source	
	Audio A/B Output	<0.004 %, 20 Hz 20 kHz	@ -1 dBFS, 600 Ω load	
ample Rate / Resolution	48 kHz / 24 Bit			
ieneral				
ower	Supply voltage	100 – 240 VAC, 50 – 60 Hz		
	Power consumption	≤15 W, ≤50 BTU/hr		
Dimensions	Form factor	19". 1 RU		
Dimensions		483 (445) × 44 × 138 (95) mm / 19 (17.5) × 1.7 × 5.4 (3.7) " outer dimensions (installing dimensions)		
A/-:-l-+	Width × height × depth		(3.7) Outer dimensions (installing dimensions)	
Veight	le :	2.3 kg / 5.1 lbs	10.07	
Cooling	Fan noise	<23 dB(A) idle,	@ 0.7m	
Environment	(temperature controlled fan)	26 dB(A) max. fan speed	(noise emission meets GK10 / DIN 15996)	
	Operating temperature	0 +45°C		
	Storage temperature	-30 +80°C		
	LL Lorenz Saltano	20 90 % relative (non-condensing)		
	Humidity	20 90 % relative (non-condensing)		